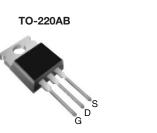


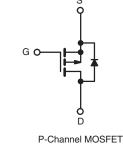
Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 60				
R _{DS(on)} (Ω)	V _{GS} = - 10 V 0.50				
Q _g (Max.) (nC)	12				
Q _{gs} (nC)	3.8				
Q _{gd} (nC)	5.1				
Configuration	Single				





FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF9Z14PbF			
	SiHF9Z14-E3			
SnPb	IRF9Z14			
	SiHF9Z14			

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	- 60	- V		
Gate-Source Voltage	V _{GS}	± 20			
Continuous Drain Current	$V_{GS} \text{ at } -10 \text{ V} \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		- 6.7		
	$T_{\rm C} = 100 ^{\circ}{\rm C}$	ID	- 4.7	А	
Pulsed Drain Current ^a	I _{DM}	- 27			
Linear Derating Factor		0.29	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	140	mJ		
Repetitive Avalanche Current ^a	I _{AR}	- 6.7	Α		
Repetitive Avalanche Energy ^a	E _{AR}	4.3	mJ		
Maximum Power Dissipation	T _C = 25 °C	PD	43	W	
Peak Diode Recovery dV/dt ^c	dV/dt	- 4.5	V/ns		
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to + 175	- °C		
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	7 0	
· · · ·	6.00 or M0 oprovi		10	lbf ∙ in	
Mounting Torque	6-32 or M3 screw		1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = - 25 V, starting T_J = 25 °C, L = 3.6 mH, R_g = 25 Ω , I_{AS} = - 6.7 A (see fig. 12).

c. $I_{SD} \leq$ - 6.7 A, dI/dt \leq 90 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq$ 175 °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50 - 3.5				°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}							
SPECIFICATIONS (T _J = 25 °C, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		IONS	MIN.	TYP.	MAX.	UNIT
Static	•	•						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$) V, I _D = - 1	250 µA	- 60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I	l _D = - 1 mA	-	- 0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	' _{GS} , I _D = -	250 µA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}	V	_{GS} = ± 20	V	-	-	± 100	nA
Zara Cata Valtaga Drain Current		V _{DS} = -	60 V, V _G	_S = 0 V	-	-	- 100	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = - 48 V, V _{GS} = 0 V, T _J = 150 °C		-	-	- 500	μA	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D	= - 4.0 A ^b	-	-	0.50	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = -25 \text{ V}, \text{ I}_{D} = -4.0 \text{ A}^{b}$		1.4	-	-	S	
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = -25 V,$ f = 1.0 MHz, see fig. 5		-	270	-	pF	
Output Capacitance	C _{oss}			-	170	-		
Reverse Transfer Capacitance	C _{rss}			-	31	-		
Total Gate Charge	Qg				-	-	12	
Gate-Source Charge	Q _{gs}	$V_{GS} = -10 \text{ V}$ $I_D = -6.7 \text{ A}, V_{DS} = -48 \text{ V},$ see fig. 6 and 13 ^b			-	-	3.8	nC
Gate-Drain Charge	Q _{gd}			-	-	5.1	1	
Turn-On Delay Time	t _{d(on)}	V _{DD} = - 30 V, I _D = - 6.7 A, R _g = 24 Ω, R _D = 4.0 Ω, see fig. 10 ^b		-	11	-	- ns	
Rise Time	t _r			-	63	-		
Turn-Off Delay Time	t _{d(off)}			-	10	-		
Fall Time	t _f				-	31	-	1
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-		
Internal Source Inductance	L _S			-	7.5	-	nH	
Drain-Source Body Diode Characteristi	cs	•						
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 6.7	٨	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	- 27	A	
Body Diode Voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = -6.7 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	- 5.5	V	
Body Diode Reverse Recovery Time	t _{rr}	- $T_J = 25 \text{ °C}, I_F = -6.7 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}^b$ Intrinsic turn-on time is negligible (turn		-	80	160	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.096	0.19	μC	
Forward Turn-On Time	t _{on}			-on is doi	minated b	y L _S and	L _D)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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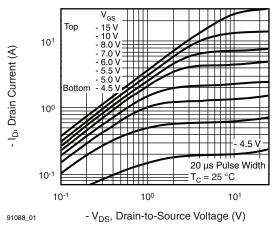
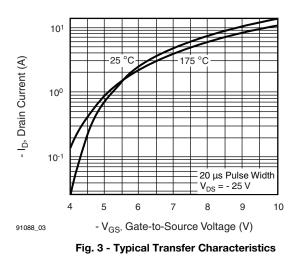


Fig. 1 - Typical Output Characteristics, T_C = 25 °C



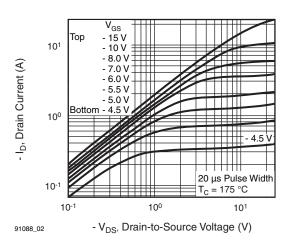


Fig. 2 - Typical Output Characteristics, T_C = 175 $^\circ$ C

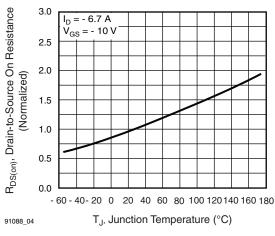


Fig. 4 - Normalized On-Resistance vs. Temperature

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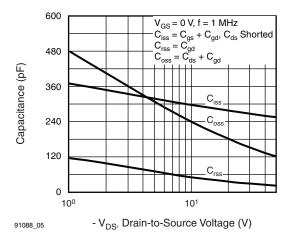


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

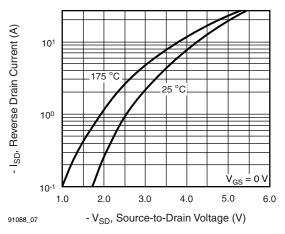


Fig. 7 - Typical Source-Drain Diode Forward Voltage

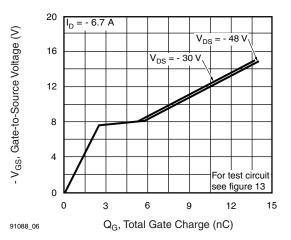


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

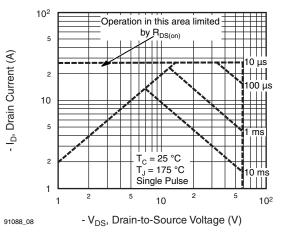


Fig. 8 - Maximum Safe Operating Area



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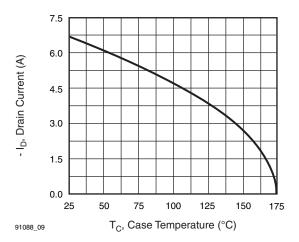


Fig. 9 - Maximum Drain Current vs. Case Temperature

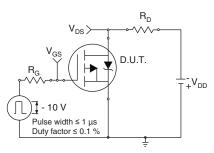


Fig. 10a - Switching Time Test Circuit

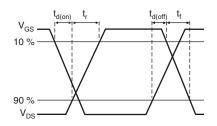


Fig. 10b - Switching Time Waveforms

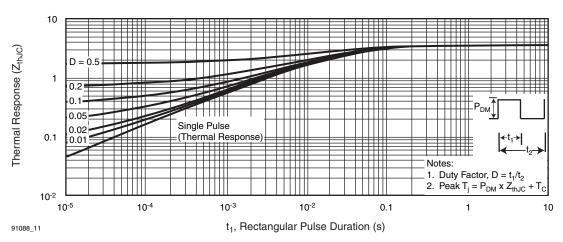


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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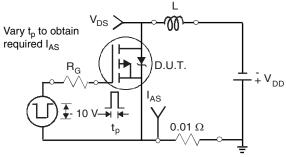


Fig. 12a - Unclamped Inductive Test Circuit

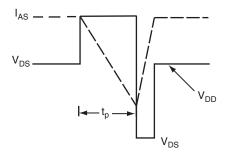


Fig. 12b - Unclamped Inductive Waveforms

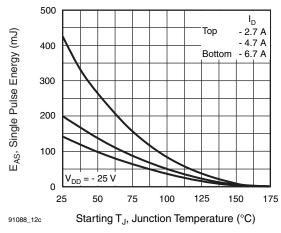


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

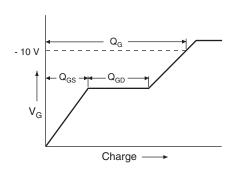


Fig. 13a - Basic Gate Charge Waveform

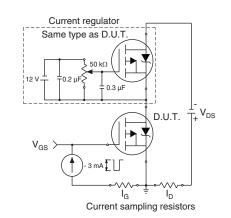
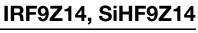


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

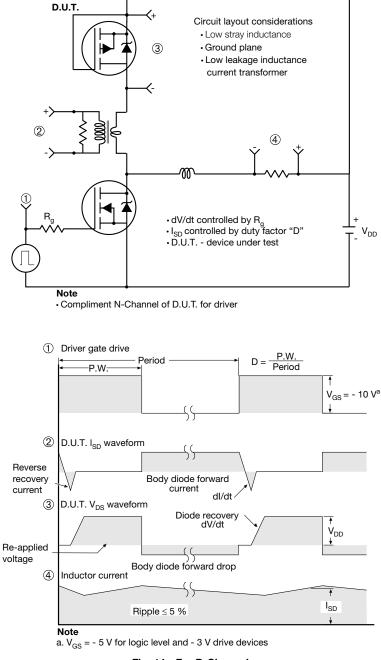


Fig. 14 - For P-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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